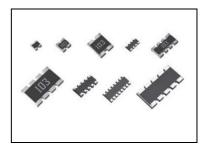
Chip resistor networks

MNR series Datasheet

Features

- 1) Can be mounted even more densely than chip resistors.
- 2) Mounting cost can be reduced by less frequency of mounting times.
- 3) Convex electrodes secures visual inspection of fillets after soldering.
- 4) ROHM resistors have obtained ISO9001 / ISO / TS16949 certification.



Part No.	Si	ze	No. of terminals	No. of elements	Type code	Packaging specifications	Quantity/Reel	Automotive grade
	(mm)	(inch)				'		available
MNR02	1005 × 2	0402 × 2	4	2	M0AP	Paper tape (2mm pitch)	10,000	Yes
MNR04	1005 × 4	0402 × 4	8	4	M0AP	Paper tape (2mm pitch)	10,000	Yes
MNR12	1608 × 2	0603 × 2	4	2	E0AP	Paper tape (4mm pitch)	5,000	Yes
MNR14	1608 × 4	0603 × 4	8	4	E0AP Paper tape (4mm pitch)		5,000	Yes
MNR15	1608 × 5	0603 × 5	10	8	E0RP	Paper tape (4mm pitch)	5,000	Yes
MNR18	1605 × 8	0602 × 8	16	8	E0AP	Paper tape (4mm pitch)	5,000	Yes
MNR32	3216 × 2	1206 × 2	4	2	J0AB	Embossed tape (4mm pitch)	4,000	Yes
MNR34	3216 × 4	1206 × 4	8	4	J5AB	Embossed tape (4mm pitch)	4,000	Yes
MNR35	3216 × 5	1206 × 5	10	8	J5R	Embossed tape (4mm pitch)	4,000	Yes

Part number description

Part No.	
MNR (Chip resistors networks)	

MNR

Size (mm [inch])
02 (1005 × 2 [0402 × 2])
04 (1005 × 4 [0402 × 4])
12 (1608 × 2 [0603 × 2])
14 (1608 × 4 [0603 × 4])
15 (1608 × 5 [0603 × 5])
18 (1605 × 8 [0602 × 8])
32 (3216 × 2 [1206 × 2])
34 (3216 × 4 [1206 × 4])
35 (3216 × 5 [1206 × 5])

M	0	Α	
Туре	COC	le	

Resistance to	lerance
F (±1%) J (±5%) (Includ	ing jumper type)

1	0	5

No	Nominal resistance							
Resistance code, 3 or 4 digits.								
000 denotes jumper type.								
	Resistance Resistance							
	tolerance code							
	F : 4 digits							
	J : 3 digits							
Е	X.)							
	$1\Omega = 1R0 \ (\pm 5\%)$							
	$9.1\Omega = 9R1 (\pm 5\%)$							
	$10\Omega = 10R0 (\pm 1\%)$							
	100 (±5%)							
	$1M\Omega = 1004 (\pm 1\%)$							
	105 (±5%)							

Products list

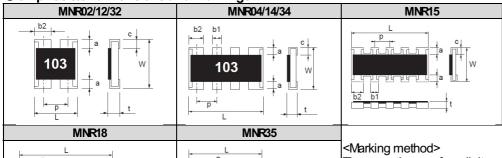
Part No.	Type code	Rated Limitir eleme (70°C) voltage		Temperature coefficient	Resistance tolerance	Resistar	Operating temperature range		
		(W)	(V)	(ppm / °C)	(%)	(Ω)		(°C)	
MNR02	MOAP	0.063/ Element	25	±200	J(±5%)	10≦R≦1M	(E24 series)	-55 ~ +155	
			Jumper t	ype : Rmax = 5	0 m Ω Max., Image	ax= 1A(Element)			
		0.063/ Element	25	+500 / -250	J(±5%)	1≦R<10	(E24 series)		
MNR04	M0AP	Oldde, Element		±200	J(±5%)	10≦R≦1M	(E24 series)	-55 ~ +155	
			Jumper t	ype:Rmax=5	iomΩ Max, Ima	ax = 1A(Element)			
		0.063/ Element	50	±100	F(±1%)	10≦R≦1M	(E24 series)		
MNR12	E0AP	0.000/ LIGHTOTIC	00	±200	J(±5%)	10≦R≦1M	(E24 series)	-55 ~ +155	
			Jumper t	ype : Rmax = 5	-	ax = 1A(Element)			
				±100	F(±1%)	10≦R≦1M	(E24 series)	 	
MNR14	E0AP	0.063/ Element	50	±500	J(±5%)	2.2≦R<10	(E6 series)	-55 ~ +155	
				±200	J(±5%)	10≦R≦1M	(E24 series)		
		Jumper type : Rmax = 50mΩ Max, Imax = 1A(Element)							
MNR15	E0RP	0.031/ Element	12.5	±200	J(±5%)	56≦R≦100k	(E96 series)	-55 ~ +125	
MNR18	E0AP	0.063/ Element	25	±200	J(±5%)	10≦R≦1M	(E24 series)	-55 ~ +125	
			Jumper type : Rmax = 50mΩ Max, Imax = 1A(Element)						
MNR32	J0AB	0.125/ Element	200	±200	J(±5%)	10≦R≦1M	(E24 series)	-55 ~ +125	
			Jumper t	ype : Rmax = 5	0mΩ Max., Ima	ax= 2A(Element)			
MNR34	J5AB	0.125/ Element	200	±200	J(±5%)	10≦R≦1M	(E24 series)	-55 ~ +125	
			Jumper t	ype:Rmax=5	0mΩ Max., Ima	ax= 2A(Element)		temperature range (°C) -55 ~ +155 -55 ~ +155 -55 ~ +155 -55 ~ +125 -55 ~ +125 -55 ~ +125	
MNR35	J5R	0.063/ Element	50	±200	J(±5%)	56≦R≦100K	(E12 series)	-55 ~ +125	

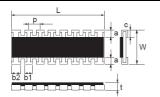
^{*} Design and specifications are subject to change without notice. Carefully check the specification sheet supplied with the product before using or ordering it.

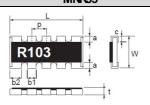
Circuit construction

MNR 02/12/32	MNR 04/14/34	MNR 15/35	MNR18
R1 R2	$\begin{array}{c} \begin{array}{c} \\ \\ \\ \\ \\ \\ \end{array} \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \end{array} \begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	R1 R2 R3 R4	R1 R2 R3 R4 R5 R6 R7 R8
R1=R2	R1=R2=R3=R4	R1=R2=R3=R4=R5=R6=R7=R8	R1=R2=R3=R4=R5=R6=R7=R8

Chip resistor dimensions and markings





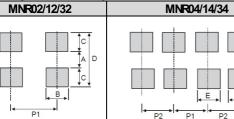


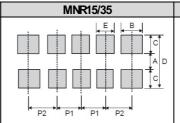
<Marking method>
There are three or four digits used for the calculation number according to IEC code and "R"is used for the decimal point.
MNR35 is \(\Gamma \) + three digits used for the calculation number according to IEC code.

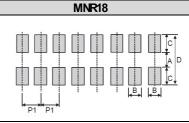
(Unit:mm)

											(Grittini)	
Part No.	Type code	(mm)	(inch)	L	W	t	а	b1	b2	С	р	Marking existence *Including jumper type
MNR02	M0AP	1005 × 2	0402 × 2	1.00±0.10	1.00 ±0.10	0.35±0.10	0.20±0.10	_	0.33 ^{+0.10} _{-0.05}	0.25±0.10	0.68	No
MNR04	M0AP	1005 × 4	0402 × 4	2.00 ±0.10	1.00 ±0.10	0.35±0.10	0.20±0.10	0.30±0.10	0.40 ±0.10	0.25±0.10	0.5	No
MNR12	E0AP	1608 × 2	0603 × 2	1.60 ±0.10	1.60 ±0.10	0.50 ±0.10	0.3±0.20	_	0.60 ±0.15	0.25±0.15	0.8	Yes
MNR14	E0AP	1608 × 4	0603 × 4	3.20±0.10	1.60 ±0.10	0.50 ±0.10	0.30±0.20	0.40 ±0.15	0.60 ±0.15	0.25±0.15	0.8	Yes
MNR15	E0RP	1608 × 5	0603 × 5	3.20±0.10	1.60 ±0.10	0.50±0.10	0.30±0.10	0.32±0.15	0.48 ±0.15	0.30±0.10	0.64	No
MNR18	E0AP	1605 × 8	0602 × 8	3.80±0.10	1.60 ±0.10	0.45±0.10	0.30±0.20	0.30±0.10	0.30 ±0.10	0.30±0.20	0.5	No
MNR32	J0AB	3216 × 2	1206 × 2	2.60 ±0.20	3.10±0.20	0.55±0.10	0.50±0.30	_	1.00 ±0.20	0.5 MAX	1.27	Yes
MNR34	J5AB	3216 × 4	1206 × 4	5.20±0.40	3.10±0.20	0.55±0.10	0.50±0.30	0.80±0.20	1.00 ±0.20	0.5 MAX	1.27	Yes
MNR35	J5R	3216 × 5	1206 × 5	6.4±0.40	3.10±0.20	0.55±0.10	0.50±0.30	0.80±0.20	1.00 ±0.20	0.50 MAX	1.27	Yes

●Land pattern example







(Unit:mm)

--- Land

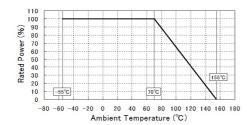
Part No.	Type code	Α	В	С	D	E	P1	P2
MNR02	M0AP	0.5	0.35 ~0.4	0.5	1.5	_	0.65 ~0.7	
MNR04	M0AP	0.5	0.4	0.5	1.5	0.3	0.5	0.5 ~ 0.55
MNR12	E0AP	1.0	0.4 ~ 0.6	0.7 ~ 0.8	2.4 ~ 2.6	_	0.8 ~ 1.0	
MNR14	E0AP	1.0	0.4 ~ 0.6	0.7 ~ 0.8	2.4 ~ 2.6	0.4	0.8	0.8 ~ 0.9
MNR15	E0RP	1.0	0.48	0.7 ~ 0.8	2.4 ~ 2.6	0.32	0.64	0.72
MNR18	E0AP	1.0	0.3	0.7 ~ 0.8	2.4 ~ 2.6	_	0.5	
MNR32	J0AB	2.1	0.8 ~ 1.0	0.8 ~ 1.0	3.7 ~ 4.1	_	1.27 ~ 1.6	
MNR34	J5AB	2.1	0.8 ~ 1.0	0.8 ~ 1.0	3.7 ~ 4.1	0.7 ~ 0.8	1.27 ~ 1.35	1.27 ~ 1.45
MNR35	J5R	2.1	0.8 ~ 1.0	0.8 ~ 1.0	3.7 ~ 4.1	0.7 ~ 0.8	1.27 ~ 1.3	1.27 ~ 1.4

MNR series Datasheet

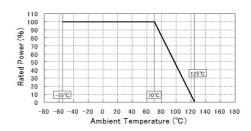
Derating curve

When the ambient temperature exceeds 70°C, power dissipation must be adjusted according to the derating curves below.

■MNR 02/04/12/14



■MNR 15/18/32/34/35



Characteristics

Toot itama	Guaranteed	Test conditions			
Test items	Resistor type	Jumper type	lest conditions		
Resistance	See "Product	s list"	20°C		
Variation of resistance with temperature	See "Product	s list"	Measurement: +25/-55, +25/+125°C		
Overload	±(2.0%+0.1Ω)	MAX 50mΩ	Test voltage is the smaller one of ① or ② ①Rated voltage(current)×2.5, 2s ②Maximum overload voltage ※		
Solderability	Anew uniform coating of minimus surface being immersed and no		Rosin-ethanol solution(25% weight) Soldering condition: 245±5°C Duration of immersion: 2.0±0.5s		
Resistance to	±(1.0%+0.05Ω) ±(1.0%+0.1Ω)※MNR35	MAX 50mΩ	Soldering condition: 260±5°C		
soldering heat	No remarkable abnormality	on the appearance.	Duration of immersion: 10±1s		
Rapid change of temperature	\pm (1.0% +0.05Ω) \pm (1.0% +0.1Ω) \times MNR35 MAX 50mΩ		Test temp: -55°C~+125°C 5cycle		
Damp heat, steady state	$\pm (3.0\% + 0.1\Omega)$	MAX 100mΩ	40°C, 93%(Relative humidity) Test time: 1,000h		
Endurance at 70°C	$\pm (3.0\% + 0.1\Omega)$	MAX 100mΩ	Rated voltage(current),70°C 1.5h:ON – 0.5h:OFF Test time: 1,000h		
Endurance	±(3.0%+0.1Ω) MAX 100mΩ		155°C(MNR02/04/12/14) 125°C(MNR15/18/32/34/35) Test time: 1,000h		
Resistance to solvent	±(1.0%+0.05Ω) ±(1.0%+0.1Ω)※MNR35	ΜΑΧ 50mΩ	23±5°C, Immersion cleaning, 5±0.5min Solvent: 2-propanol		
Bend strength of	$\pm (1.0\% + 0.05\Omega)$	MAX 50mΩ			
the end face plating	Without mechanical damaç	ge such as breaks.	-		

Compliance Standard(s): IEC60115-8

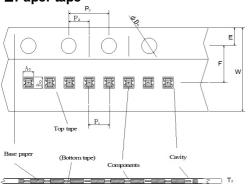
JISC 5201-8

※Maximum overload voltage (Test voltage)

				,				
MNR02	MNR04	MNR12	MNR14	MNR15	MNR18	MNR32	MNR34	MNR35
50V	50V	100V	100V	25V	50V	400V	400V	100V

●Tape cimensions

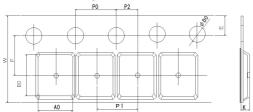
■Paper tape



						(Unit:mm)
Part No.	Type code	W	F	E	A0	B0
MNR02	MOAP	8.0±0.3	3.5±0.05	1.75±0.1	1.17±0.1	1.17±0.1
MNR04	MOAP	8.0±0.3	3.5±0.05	1.75±0.1	1.2±0.1	2.2±0.1
MNR12	E0AP	8.0±0.3	3.5±0.05	1.75±0.1	1.8±0.1	1.8±0.1
MNR14	E0AP	8.0±0.3	3.5±0.05	1.75±0.1	1.8±0.1	3.4±0.1
MNR15	EORP	8.0±0.3	3.5±0.05	1.75±0.1	1.8±0.1	3.4±0.1
MNR18	E0AP	8.0±0.3	3.5±0.05	1.75±0.1	1.95±0.15	4.1 ±0.15

Part No.	Type code	W	F	E	A0	В0
MNR02	MOAP	Ф1.5 ^{+0.1}	4.0±0.1	2.0±0.1	2.0±0.05	MAX0.5
MNR04	MOAP	Ф1.5 ^{+0.1}	4.0±0.1	2.0±0.1	2.0±0.05	MAX1.1
MNR12	E0AP	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
MNR14	E0AP	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
MNR15	EORP	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
MNR18	E0AP	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1

■ Embossed tape



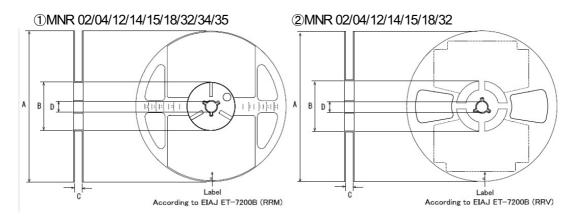
			(Unit:mm)	
Typo				

Part No.	Type code	W	F	Е	A0	В0
MNR32	J0AB	8.0±0.3	3.5±0.05	1.75±0.1	3.0±0.1	3.5±0.1
MNR34	J5AB	12.0±0.3	5.5±0.05	1.75±0.1	3.4±0.1	5.6±0.1
MNR35	J5R	12.0±0.3	5.5±0.05	1.75±0.1	3.4±0.1	6.6±0.1

Part No.	Type code	W	F	Е	A0	ВО
MNR32	J0AB	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	0.9±0.1
MNR34	J5AB	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	1.0±0.15
MNR35	J5R	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	1.0±0.15

Reel dimensions

Using two kinds reets for taping.



(Unit:mm)

					(3
Part No.	Type code	А	В	С	D
MNR02	M0AP				
MNR04	M0AP				
MNR12	E0AP			.4.0	
MNR14	E0AP	_	.,	9 ^{+1.0}	
MNR15	EORP	Ф180 ⁰ -1.5	Ф60 ⁺¹	0	Ф13±0.2
MNR18	E0AP	-1.5			
MNR32	J0AB				
MNR34	J5AB			13 +1.0	
MNR35	J5R			0	

Notice

Precaution on using ROHM Products

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

(1.1010 1) medical Equipment Glacomedation of the operation								
JAPAN	USA	EU	CHINA					
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSⅢ					
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII					

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

Precaution Regarding Intellectual Property Rights

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